© Cot	erial Composition pyright 2005. IPC, Ba ational and Pan-Ame	annockbur	rn, Illinois. A	ll rights reserved utions.	under both	This docume level parts, t	ent is a decla he declaratio	aration on enco	of the subsompasses a	stances v 11 lower	vithin the i level mate	nanufactur rials for wl	er listed it hich the m	em. No anufac	ote: if the	e item is an as s engineering	sembly with lower sembly with lower sembly with lower sembla is a sembla in the sembla in the sembla is a sembla in the sembla in the sembla is a sembla in the se
					Form Type Distribute						ous Materia	als and Mfg Information					
Supplier Information																	
Company name*			Company unique ID			Unique ID Authority					Response Date*						
onsemi											2024-05-05						
Contact Name			Title - Contact			Phone - Contact*					Email - Contact*						
Product-Env-Stewards			Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com						
Authorized Representative*			Title - Representative			Phone - Representative*					Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com						
Requester Item N	quester Item Number Mfr Iter		lumber			Effective D	Date	ate Version Ma		Manufacturing Site		1	Weight	*	UOM	Unit Type	
				XDFN4 HZ 3.0V LDO 250 mA, Ultra-Low Noise and High PSRR		Ultra-Low	2024-05-05	5		Т	THB		1	1.434		mg	Each
Manufacturing Procce	ess Information																
Terminal Plating /	Plating / Grid Array Material Terminal Base		minal Base A	lloy	J-STD-020 MSL Rating		Peak Process Body T		Body Tem	perature Max Time at Peak		Temperature Numbe		Number c	of Reflow Cyc	les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		(no CU	CU Alloy 1		1		260		С		30		secon	ds 3	3		
Comments																	
vel 1 - maximum time at p	eak temperature du	ring solde	ering is 10-30) seconds													
or more information regar	ding material comp	osition pl	ease refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.09	mg	Supplier	Silicon (Si)	7440-21-3		0.09	mg
Die Attach Tape	0.13	mg	Supplier	Oxirane, (chloromethyl)-, homopolymer	24969-06-0		0.0195	mg
			Supplier	2-Propenoic acid, 2-methyl-, polymer with butyl 2-propenoate and methyl 2- methyl-2-propenoate	25035-69-2		0.0195	mg
			Supplier	Proprietary	Proprietary Data		0.013	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0585	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0195	mg
Lead Frame	0.58	mg	Supplier	Tin (Sn)	7440-31-5		0.0014	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0013	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0014	mg
			Supplier	Copper (Cu)	7440-50-8		0.5758	mg
Mold Compound-Black	0.6	mg		Epoxy resin	proprietary data		0.0282	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.06	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0006	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.483	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0282	mg
Plating	0.004	mg	Supplier	Palladium (Pd)	7440-05-3		0.0001	mg
			В	Nickel (Ni)	7440-02-0		0.0035	mg
			Supplier	Gold (Au)	7440-57-5		0.0004	mg
Wire Bond - Au	0.03	mg	Supplier	Gold (Au)	7440-57-5		0.03	mg